

L Number	Hits	Search Text	DB	Time stamp
1	1403	header adj frame	USPAT; US-PGPUB; EPO; JPO; DERWENT	2002/08/09 07:53
2	305	(header adj frame) and pin	USPAT; US-PGPUB; EPO; JPO; DERWENT	2002/08/09 07:58
3	44	((header adj frame) and pin) and mm	USPAT; US-PGPUB; EPO; JPO; DERWENT	2002/08/09 07:53
4	206	(socket adj assembly) near3 contact	USPAT	2002/08/09 07:58
5	125	((socket adj assembly) near3 contact) and pin	USPAT; US-PGPUB; EPO; JPO; DERWENT	2002/08/09 08:07
6	11	((socket adj assembly) near3 contact) and pin) and thickness and mm	USPAT; US-PGPUB; EPO; JPO; DERWENT	2002/08/09 07:58
7	18	((socket adj assembly) near3 contact) and pin) and mm and (thickness length width)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2002/08/09 08:08
8	272	chip near1 carrier near1 socket	USPAT; US-PGPUB; EPO; JPO; DERWENT	2002/08/09 08:07
9	116	(chip near1 carrier near1 socket) and pin	USPAT; US-PGPUB; EPO; JPO; DERWENT	2002/08/09 08:07
10	14	((chip near1 carrier near1 socket) and pin) and mm and (thickness length width)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2002/08/09 08:08
11	16	((chip near1 carrier near1 socket) and pin) and mm	USPAT; US-PGPUB; EPO; JPO; DERWENT	2002/08/09 08:08
12	74	((chip near1 carrier near1 socket) and pin) and (thickness length width)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2002/08/09 08:09
13	60	((chip near1 carrier near1 socket) and pin) and (thickness length width)) not (((socket adj assembly) near3 contact) and pin) and mm and (thickness length width))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2002/08/09 08:17
14	14	((chip near1 carrier near1 socket) and pin) and (thickness length width)) not (((chip near1 carrier near1 socket) and pin) and (thickness length width)) not (((socket adj assembly) near3 contact) and pin) and mm and (thickness length width)) not (((chip near1 carrier near1 socket) and pin) and mm and (thickness length width)))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2002/08/09 08:17